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U.S. DEPARTMENT OF COMMERCE U.S. Patent and Trademark Office



102246876

original documents or copy thereof.

1. Name of conveying party(ies):

Haleos, Inc.

2. Name and address of receiving party(ies)

Name: Shipley Company, L.L.C.

Internal Address:

Street Address: 455 Forest Street

City: Marlborough State: MA Zip: 01752

Additional name(s) of conveying party(ies) attached? Yes No

3. Nature of conveyance:

- Assignment Merger Security Agreement Change of Name Other

Execution Date: 9/11/02

Additional name(s) & address(es) attached? Yes No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No.(s)

B. Patent No.(s)

See attached schedule

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Darryl P. Frickey, Esq.

Internal Address: Shipley Company, L.L.C

Street Address: 455 Forest Street

City: Marlborough State: MA Zip: 01752

6. Total number of applications and patents involved:

7. Total fee (37 CFR 3.41) \$ 4,725.00

- Enclosed Authorized to be charged to deposit account

8. Deposit account number:

141449

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9. Signature.

Repln. Ref: 10/16/2002 DBYRNE 0011441000 DAN:141449 Name: Darryl P. Frickey

Signature: Darryl P. Frickey

Date: 10/11/02

Total number of pages including cover sheet, attachments, and documents:

Mail documents to be recorded with required cover sheet information to: Commissioner of Patents & Trademarks, Box Assignments Washington, D.C. 20231

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SCHEDULE A

INTELLECTUAL PROPERTY

PATENTS

| Habadero Docket | Country | Serial No. | Title | Publication No. |
|-----------------|---------|------------|--|-----------------|
| 123 | US | 09/824205 | OPTOELECTRONIC PACKAGES HAVING INSULATION LAYERS | 20010036344 |
| 119 | US | 09/824638 | TWO-DIMENSIONAL ARRAY FOR ROTATIONAL ALIGNMENT OF POLARIZATION MAINTAINING OPTICAL FIBER | 20010055460 |
| | US | 09/825990 | SINGLE-PIECE ALIGNMENT FRAME FOR OPTICAL FIBER ARRAYS | 20020021881 |
| 121 | US | 09/827183 | METHOD AND DEVICES FOR COUPLING OPTOELECTRONIC PACKAGES | 20010031117 |
| 148 | US | 09/828842 | OPTICAL SWITCH AND METHOD FOR MAKING | |
| 124 | US | 09/833282 | FIBER OPTIC ARRAY SWITCH | 20010048785 |
| 126, 127 | US | 09/835106 | OPTICAL WAVEGUIDE SWITCH | 20010041026 |
| 125 | US | 09/835863 | CONNECTOR STRUCTURE FOR INTEGRATED OPTIC WAVEGUIDE DEVICES | 20010041029 |
| 128 | US | 09/845773 | OPTICAL WAVEGUIDE SWITCH | 20020025104 |
| 129 | US | 09/847798 | SINGLE MASK TECHNIQUE FOR MAKING POSITIVE AND NEGATIVE MICROMACHINED | 20010050266 |
| 131 | US | 09/851376 | OPTICAL WAVEGUIDE FERRULE AND METHOD OF MAKING AN OPTICAL WAVEGUIDE | 20010055449 |
| 201, 149-P | US | 09/852709 | OPTICAL SWITCH ASSEMBLY AND METHOD FOR MAKING | 20020025107 |
| 130 | US | 09/853250 | MULTI-LEVEL LITHOGRAPHY MASKS | 20020031711 |
| 132 | US | 09/858999 | MULTI-LEVEL OPTICAL STRUCTURE AND METHOD OF MANUFACTURE | |
| 133 | US | 09/860825 | OPTICAL WAVEGUIDE DEVICES AND METHODS OF FABRICATING THE SAME | 20020028037 |
| 134 | US | 09/862037 | METHOD OF FABRICATING OPTICAL FILTERS | 20020012172 |
| 135 | US | 09/862593 | METHOD FOR MAKING INTEGRATED OPTICAL WAVEGUIDES AND MICROMACHINED FEATURES | 20020005050 |
| 140-P | US | 09/878486 | METHOD FOR CLEAVING INTEGRATED OPTIC WAVEGUIDES TO PROVIDE A SMOOTH WAVEGUIDE ENDFACE | 20020001435 |
| 152-P | US | 09/878810 | OPTICAL FIBER FERRULE MADE FROM DRY ETCHED PARTS | 20010051026 |
| 138 | US | 09/884428 | TWO-DIMENSIONAL FIBER ARRAY AND METHOD OF MANUFACTURE | |
| 216 | US | 09/884873 | METHOD OF FABRICATING AN OPTICAL FIBER ARRAY USING PHOTSENSITIVE | |
| 142 | US | 09/903077 | FRONTSIDE/BACKSIDE ALIGNMENT STRUCTURES FOR STACKED DEVICES | |

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INTELLECTUAL PROPERTY

PATENTS

| Habenero Docket | Country | Serial No. | Title | Publication No. |
|-----------------|---------|------------|--|-----------------|
| 136 | US | 09/911834 | METHOD FOR MAKING 3-D STRUCTURES BY ETCHING MASK WITH GRADED COMPOSITION | |
| 230 | US | 09/923842 | ALIGNMENT APPARATUS AND METHOD FOR ALIGNING STACKED DEVICES | |
| 215/146 | US | 09/930566 | MICROLENSSES AND METHOD OF FABRICATION | |
| 150 | US | 09/957755 | FIBER ARRAY WITH SUPPORT POST | |
| 162 | US | 09/966973 | OPTICAL DEVICE PACKAGE | |
| 151 | US | 09/974745 | METHOD FOR PATTERNED DEPOSITION OF CONFORMAL COATINGS | |
| 153 | US | 09/978804 | FILLED TRENCH/PLANARIZATION METHOD FOR MAKING OPTICAL WAVEGUIDES | |
| 178 | US | 09/981944 | 2-D FIBER ARRAYS WITH ROTATED FIBERS FOR ACCURATE CORE POSITIONING | |
| 165/157 | US | 09/983984 | VARIABLE WIDTH WAVEGUIDE FOR MODE-MATCHING AND METHOD FOR MAKING | |
| 155 | US | 09/985377 | METHOD FOR FORMING OPTICAL DEVICES AND OPTICAL DEVICES FORMED THEREBY | |
| 159 | US | 09/987139 | SEMICONDUCTOR MODULE WITH SUBMOUNT HAVING TRANSMISSION LINE AND METHOD FOR FORMING | |
| 163 | US | 09/987766 | OPTICAL ASSEMBLY COUPLING WITH INTEGRATED OPTICAL DEVICES AND METHOD FOR MAKING | |
| 161 | US | 09/988055 | OPTICAL BENCH WITH ALIGNMENT SUBASSEMBLY | |
| | | 09/990509 | | |
| 144 | US | 09/999332 | SINGLE MASK PROCESS FOR PATTERNING GRAY SCALE FEATURES AND MICROMACHINED FEATURES | |
| 158 | US | 09/999517 | WAFER-LEVEL PACKAGING FOR OPTOELECTRONIC DEVICES | |
| 173 | US | 10/013084 | OPTOELECTRONIC PACKAGING WITH STEPPED VIA-STRUCTURE | |
| 174 | US | 10/013793 | STRUCTURE FOR FRONTSIDE/BACKSIDE ALIGNMENT OF MICROMACHINED CHIPS | |
| 174B | US | 10/015211 | STRUCTURE FOR FRONTSIDE/BACKSIDE ALIGNMENT OF MICROMACHINED CHIPS | |
| 176 | US | 10/022726 | FTIR/THz SWITCH IMPROVEMENTS | |
| 141 | US | 10/037971 | FIBER ARRAY WITH V-GROOVE CHIP AND MOUNT | |
| | | 10/041517 | | |

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PATENTS

| Habenero Docket | Country | Serial No. | Title | Publication No. |
|-----------------|---------|------------|---|-----------------|
| 164 | US | 10/054575 | OPTICAL CONNECTOR SYSTEM | |
| 180 | US | 10/066299 | OPTICAL PACKAGE HAVING A VERTICAL OPTOELECTRONIC CHIP | |
| 181 | US | 10/071,261 | MICROMACHINING WITH BOTH DRY AND WET ETCHING | |
| 177 | US | 10/071871 | METHOD FOR PASSIVELY LOCATING A FIBER STUB IN A GROOVE | |
| 183/184 | US | 10/076568 | STRUCTURES MADE BY COMBINED ETCHING | |
| 179 | US | 10/081995 | METHOD FOR MAKING A VERTICAL TAPERED WAVEGUIDE WITH A MOVING MASK | |
| 193 | US | 10/113817 | OPTICAL FIBERS FOR COUPLING TO DIFFUSED WAVEGUIDES | |
| 195 | US | 10/124612 | WET + DRY ETCHING PROCESS ON <10> SILICON AND RESULTING STRUCTURES | |
| 202 | US | 10/126491 | SOLDER PADS AND METHOD OF MAKING A SOLDER PAD | |
| 203 | US | 10/126938 | OPTICAL FIBER ATTACHED TO A SUBSTRATE | |
| 206 | US | 10/135192 | VENTING OPTICAL MICROBENCH | |
| 126,127 | US | 60/201347 | OPTICAL WAVEGUIDE SWITCH | |
| 152-P | US | 60/235391 | OPTICAL FIBER FERRULE MADE FROM DRY ETCHED PARTS | |
| 156 | US | 60/243451 | FILLED TRENCH/PLANARIZATION METHOD FOR MAKING OPTICAL COUPLERS | |
| 147 | US | 60/245077 | AUTOMATED PALLETIZED ASSEMBLY FOR MICROOPTICAL DEVICES | |
| 170 | US | 60/255867 | CONNECTORIZED SILICON OPTOELECTRONIC PACKAGE | |
| 214 | US | 60/266931 | V-GROOVE WITH TAPERED DEPTH | |
| 182 | US | 60/267368 | 2-D WAVEGUIDE ARRAY HAVING ETCHED FRAME | |
| 186 | US | 60/270467 | CENTRIFUGAL METHOD OF MAKING ASPHERIC LENSLETS | |
| 185 | US | 60/271529 | RECESSED STRUCTURES MADE BY COMBINED ETCHING | |
| 189 | US | 60/275736 | METHOD OF MAKING A WAVEGUIDE IN SILICON BY THERMAL OXIDATION | |
| 188 | US | 60/275744 | FIBER ARRAY HAVING BUCKLING FIBERS FOR AXIAL COMPRESSIBILITY | |
| 191 | US | 60/276741 | WAFER-LEVEL ASSEMBLY OF OPTOELECTRONIC CONNECTOR | |
| 192 | US | 60/276742 | MT-STYLE FERRULE HAVING INTEGRAL HEATSINK FOR OPTOELECTRONIC MODULE | |
| 190 | US | 60/276743 | MICROBELLOWS POSITIONING STAGE | |

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INTELLECTUAL PROPERTY

PATENTS

| Habano Docket | Country | Serial No. | Title | Publication No. |
|---------------|---------|------------|---|-----------------|
| 194 | US | 60/280573 | SUBMOUNT FOR VCSEL CONNECTOR | |
| 197 | US | 60/283803 | OPTICAL SUBMOUNT WITH CYLINDRICAL LENS | |
| 204 | US | 60/286190 | TUNABLE ETALON | |
| 209 | US | 60/292651 | WICK-STOP FIBER OPTIC ARRAY SUBSTRATE | |
| 210 | US | 60/293634 | SELF-ALIGNING FIBER OPTIC ARRAY | |
| 200 | US | 60/294867 | MICROMACHINED ETALON | |
| 196 | US | 60/294869 | MAGNETOHYDRODYNAMIC OPTICAL SWITCH | |
| 199 | US | 60/295175 | DISCRETE-WAVELENGTH TUNABLE LASER | |
| 198 | US | 60/295556 | SHADOW MASK FOR NONPLANAR SUBSTRATES | |
| 212 | US | 60/299241 | MICRO-OPTICAL BENCH WITH TRANSVERSE PIN FOR DEVICE LOCATION | |
| 211 | US | 60/299890 | WAVEGUIDE FABRICATION METHOD AND RESULTING WAVEGUIDE | |
| 217 | US | 60/300166 | FIBER ARRAY HAVING FLEXIBLE LEAF SPRINGS | |
| 213 | US | 60/300201 | VERTICAL REFLECTOR TYPE OPTICAL SUBMOUNT MADE BY COMBINED WET + DRY ETCHING | |
| 228 | US | 60/300964 | GUILLOTINE FOR FIBER OPTICS | |
| 218 | US | 60/301341 | PASSIVE ALIGNMENT FOR STACKED MICROMACHINED CHIPS | |
| 229 | US | 60/304927 | 2XN FIBER ARRAY WITH PASSIVE ALIGNMENT | |
| | | 60/306568 | | |
| 222 | US | 60/309751 | OPTICAL SUBMOUNT WITH RETAINING SPRING | |
| 223 | US | 60/310378 | WAFER-LEVEL TESTING OF SILICON OPTICAL BENCH DEVICES | |
| 224 | US | 60/318189 | FIBER ARRAY HAVING FIBERS BONDED TO SUBSTRATE WITH SOLDER GLASS | |
| 231 | US | 60/325043 | 2-D FIBER OPTIC ARRAY WITH CROSS-FIBERS FOR ALIGNMENT | |
| 220 | US | 60/327397 | V-GROOVE WITH FIDUCIAL FOR A FIBER STOP | |
| 221 | US | 60/327397 | MULTIPLE-POSITION PASSIVE ALIGNMENT OF PRECISION MECHANICAL DEVICES | |
| 225 | US | 60/336933 | TAPERED WAVEGUIDE FOR COUPLING BETWEEN CHANNEL WAVEGUIDE AND RIB WAVEGUIDE | |
| 232 | US | 60/337007 | RIGHT ANGLE FIBER OPTIC CONNECTOR | |
| | WO | 99US1673 | OPTOELECTRONIC MODULE AND METHOD OF MAKING SAME | 200031771 |
| 172 | WO | US01/48383 | OPTICAL WAVEGUIDE TERMINATION WITH VERTICAL AND HORIZONTAL MODE SHAPING | |

Schedule A

**Intellectual Property
Patents**

| <u>Country U.S.</u> | | |
|--|----------------------|--------------------|
| <u>Title</u> | <u>Serial Number</u> | <u>Filing Date</u> |
| Fiber Array with Passive Alignment | 10/194,954 | 7/11/02 |
| Etching Process for Micromachining Crystalline Materials and Devices Fabricated Thereby | 10/199,476 | 7/19/02 |
| Etching Process for Micromachining Crystalline Materials and Devices Fabricated Thereby | PCT/US02/23177 | 7/19/02 |
| Silicon Optical Microbench Device and Wafer-Level Testing Thereof | 10/214,433 | 8/6/02 |
| Optical Submount with Retaining Spring and Method for Fabrication Thereof | 10/211,951 | 8/2/02 |
| Method for Molding A Shaped Optical Fiber Tip | 09/681,969 | 7/2/01 |
| Fiber Array Switch Having Micromachined Front Face with Roller Balls | 09/728,895 | 12/1/00 |
| Method for Making Fiber Array Having Protruding Optical Fibers and Resulting Fiber Array | 09/814,128 | 3/22/01 |
| Micromachined, Etalon-Based Optical Fiber Pressure Sensor | 09/814,526 | 3/22/01 |
| V-Groove Chip with Wick-Stop Trench for Improved Fiber Positioning | 09/526,922 | 3/16/00 |
| Fiber Array with Wick Stop For Improved Fiber Positioning | 09/742,179 | 12/20/00 |

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Patents**

| <u>Country U.S.</u> | | |
|---|--|--------------------|
| <u>Title</u> | <u>Serial Number</u> | <u>Filing Date</u> |
| Optical Device Package for Flip-Chip Mounting | 10/013,984 | 12/10/01 |
| Fiber Optic Pressure Sensor | 09/814,526 | 3/22/01 |
| Inductive Magnetic Recording head having inclined magnetic read/write pole and method of making same | 09/560,418 | 4/27/00 |
| Single mask lithographic process for patterning multiple types of surface features | 09/519,165 | 3/6/00 |
| Optical Array for Preventing Flow of Glue Between Fibers and Waveguide | 09/713,117 | 11/15/00 |
| 2-Dimensional Optional Fiber Array Made from etched sticks having notches | 09/615,101 | 7/13/00 |
| Optoelectronic device – optical fiber connector having micromachined pit for passive alignment of the optoelectronic device | 09/574,482 | 5/19/00 |
| Glass Bonded Fiber Array and Method for the Fabrication Thereof | newly filed/not assigned PCT/US02/28765 | 9/9/02 |

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ADDENDUM TO SCHEDULE A

And all other patent applications and foreign counterparts (if any) and any continuations, continuations-in-part, modifications, revisions, divisions, reissues, extensions and renewals thereto and all processes, apparatus, and components for which the manufacture, sale or use is covered by or based on the foregoing.

1143126.1

MASTER ASSIGNMENT

For valuable consideration, the receipt of which is hereby acknowledged, Halcos, Inc., a Virginia corporation, with its principal place of business at 3150 State Street, Blackburg, Virginia ("Halcos"), hereby assigns and transfers to Shipley Company, L.L.C., a Delaware limited liability company, with its principal place of business at 455 Forest Street, Marlborough, Massachusetts and its successors and assigns (collectively hereinafter called the "Assignee"), its entire right, title and interest in the United States and throughout the world in and to: (i) the inventions and improvements which are the subject of the Letters Patents and Patent Applications set forth on Schedule A and Addendum to Schedule A attached hereto (the "Patents"); (ii) any and all instruments of assignment and/or other instruments pursuant to which Halcos became vested with ownership of the Patents, together with any and all rights and improvements acquired pursuant to the terms of said instruments; (iii) the instruments, patents and patent applications and any corresponding foreign patents and foreign patent applications based in whole or in part on any and all inventions claimed by the Patents; (iv) any and all divisions, continuations, reissues, extensions or other applications based on the Patents, together with Halcos' entire rights under the Paris Convention; and (v) any and all United States and foreign patents, utility models, and design registrations granted on the Patents; the same to be held and enjoyed by the Assignee for its own use and enjoyment and that of its successors, assigns, and other legal representatives, to the end of the term or terms for which said patents (including without limitation the "Patents") are or may be granted or renewed as fully and entirely as the same would have been held and enjoyed by Halcos if this assignment had not been made, together with all its claims for damages by reason for past or future infringement of said patents, with the right to sue for and collect the same for its own use and enjoyment, and for use and enjoyment of its successors, assigns, or other legal representatives.

IN WITNESS WHEREOF, the undersigned has executed this Assignment on this 11 day of September, 2002.

Halcos, Inc.
(f/k/a ACT MicroDevices, Inc.)

By: [Signature]
Name: David W. Sharr
Title: President

Commonwealth of Virginia)
COUNTY of Montgomery) SS.

On this 11th day of September, 2002, David W. Sharr appeared before me, known to me to be the person who executed the foregoing instrument, and acknowledged that the foregoing instrument is his/her free act and deed on behalf of Halcos, Inc., with authority so to do.

NOTARIAL SEAL

[Signature]
Notary Public
My Commission Expires: Dec 31, 2005